

**Cinterion**® ELS61-USA HW&SW Delta Description

Description of HW&SW differences from ELS61-US B2 to ELS61-USA B1 revisions

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## **Contents**

| 1 | Introduction |   |   |
|---|--------------|---|---|
|   | 1.1          | Related Documents   | 4 |
| 2 | Hard         | dware differences and changes from ELS61-US B2 to ELS61-USA | 5 |
|   | 2.1          | Overview  | 5 |
|   | 2.2          | Schematic Changes   | 5 |
|   |              | PCB Placement Changes                                       |   |
|   |              | Comparison of PCB Layout, Layer by Layer                    |   |
|   |              | BOM Changes   |   |
| 3 | Soft         | ware differences and changes from ELS61-US B2 to ELS61-USA  | 7 |

# 1 Introduction

This document describes the differences and changes of Boxwood ELS61-USA HW B1 version from ELS61-US HW B2 PCB(A) design.

## 1.1 Related Documents

- [1] Title
- [2] Title

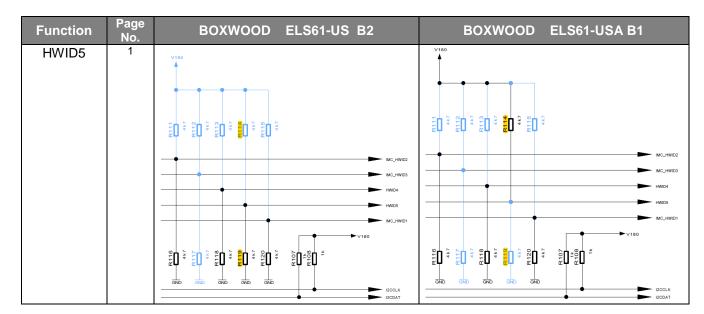
# 2 Hardware differences and changes from ELS61-US B2 to ELS61-USA

## 2.1 Overview

The major difference and change between ELS61-US B2 and ELS61-USA B1 PCB design is only the HWID resistor to identify different products.

# 2.2 Schematic Changes

Details of schematic change shown as below:



# 2.3 PCB Placement Changes

Acturally there is no PCB layout change, and only the assembly parts is different for HWID resistors R114 & R119 shown as below:

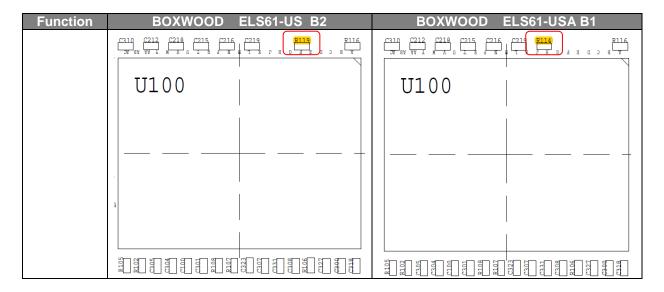


Figure 1: ELS61-USA B1 faceplan assembly parts top view

## 2.4 Comparison of PCB Layout, Layer by Layer

ELS61-USA shares the same PCB of ELS61-US.

## 2.5 BOM Changes

Details of BOM change shown as below:

|      | BOXWOOI       | D ELS61-US B2    | BOXWOOD ELS61-USA B1 |                  |
|------|---------------|------------------|----------------------|------------------|
| Ref  | SAP Part No.  | Part Description | SAP Part No.         | Part Description |
| R114 | N.A.          |                  | V24842-C472-J        | RES 0201 4K7 5%  |
| R119 | V24842-C472-J | RES 0201 4K7 5%  | N.A.                 |                  |

# 3 Software differences and changes from ELS61-US B2 to ELS61-USA

- 1. VoLTE
  - VoLTE Implementation according to AT&T requirement
- 2. CSFB
  - Basic Implementation of CSFB (circuit-switched fallback)
  - CSFB Enhancements as requested by AT&T
- 3. 3G Voice Call/CSD
- 4. DTMF
  - Sending DTMF during Voice Call
  - Support of DTMF Control Digits Separator
- 5. Supplementary Service
  - Call Barring/Call Forwarding/Call Waiting/Call Hold and so on
- 6. TTY
- 7. BIP
  - Add the Default (Network) Bearer Support for BIP

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